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TOR Rectifier

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions	
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage3	600	_	_	V	$V_{GE} = 0V, I_{C} = 250\mu A$	
$\Delta V_{(BR)CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	_	0.64	_	V/°C	$V_{GE} = 0V$, $I_C = 1.0mA$	
V _{CE(on)}	Collector-to-Emitter Saturation Voltage	_	1.58	1.8		$I_{C} = 8.0A$	$V_{GE} = 15V$
		_	2.05	_	V	I _C = 14.0A	See Fig. 2, 5
		_	1.68	_		$I_C = 8.0A, T_J = 150^{\circ}C$	
V _{GE(th)}	Gate Threshold Voltage	3.0	_	6.0		$V_{CE} = V_{GE}$, $I_C = 250\mu A$	
$\Delta V_{GE(th)}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	_	-9.5	_	mV/°C	$V_{CE} = V_{GE}$, $I_C = 250\mu A$	
g _{fe}	Forward Transconductance	3.65	5.48	_	S	$V_{CE} = 100V, I_{C} = 8.0A$	
I _{CES}	Zero Gate Voltage Collector Current	_	_	250	μA	$V_{GE} = 0V, V_{CE} = 600V$	
		_	_	1000		$V_{GE} = 0V, V_{CE} = 600V,$	$T_J = 150$ °C
V _{FM}	Diode Forward Voltage Drop	_	1.5	1.8	V	I _C =4.0A	See Fig. 13
		_	1.4	1.7		I _C =4.0A, T _J = 150°C	
I _{GES}	Gate-to-Emitter Leakage Current	_	_	±100	nA	$V_{GE} = \pm 20V$	

Switching Characteristics $@T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions	
Q _q	Total Gate Charge (turn-on)	_	15	22		I _C = 8.0A	
Qge	Gate - Emitter Charge (turn-on)	_	2.42	3.6	nC	V _{CC} = 400V See Fig. 8	
Q _{gc}	Gate - Collector Charge (turn-on)	_	6.53	9.8		V _{GE} = 15V	
t _{d(on)}	Turn-On Delay Time	_	76	_		T _J = 25°C	
t _r	Rise Time	_	32	_	ns	$I_C = 8.0A, V_{CC} = 480V$	
t _{d(off)}	Turn-Off Delay Time	_	815	1200		$V_{GE} = 15V, R_{G} = 100\Omega$	
t _f	Fall Time	_	720	1080		Energy losses include "tail" and	
E _{on}	Turn-On Switching Loss	_	0.31	_		diode reverse recovery.	
E _{off}	Turn-Off Switching Loss	_	3.28	_	mJ	See Fig. 9, 10, 18	
E _{ts}	Total Switching Loss	_	3.60	10.9			
E _{ts}	Total Switching Loss		1.46	2.6	mJ	I _C = 5.0A	
t _{d(on)}	Turn-On Delay Time	_	70	_		T _J = 150°C, See Fig. 10,11, 18	
t _r	Rise Time	 	36	_	ns	$I_C = 8.0A, V_{CC} = 480V$	
t _{d(off)}	Turn-Off Delay Time	_	890	_		$V_{GE} = 15V, R_{G} = 100\Omega$	
t _f	Fall Time	_	890	_		Energy losses include "tail" and	
E _{ts}	Total Switching Loss	_	3.83	_	mJ	diode reverse recovery.	
LE	Internal Emitter Inductance	_	7.5	_	nH	Measured 5mm from package	
C _{ies}	Input Capacitance	_	280	_		$V_{GE} = 0V$	
C _{oes}	Output Capacitance	_	30	_	pF	V _{CC} = 30V See Fig. 7	
C _{res}	Reverse Transfer Capacitance	_	4.0	_		f = 1.0MHz	
t _{rr}	Diode Reverse Recovery Time	_	28	42	ns	T _J = 25°C See Fig.	
		_	38	57		T _J = 125°C 14 I _F =4.0A	
Irr	Diode Peak Reverse Recovery Current	_	2.9	5.2	Α	T _J = 25°C See Fig.	
		_	3.7	6.7		$T_{J} = 125^{\circ}C$ 15 $V_{R} = 200V$	
Q _{rr}	Diode Reverse Recovery Charge	_	40	60	nC	$T_J = 25^{\circ}C$ See Fig.	
		_	70	105		$T_{J} = 125^{\circ}C$ 16 di/dt = 200A/µs	
di _{(rec)M} /dt	Diode Peak Rate of Fall of Recovery	 	280	_	A/µs	T _J = 25°C See Fig.	
(/	During t _b		235	_	1 .	T _J = 125°C 17	

Details of note 1 through 4 are on the last page

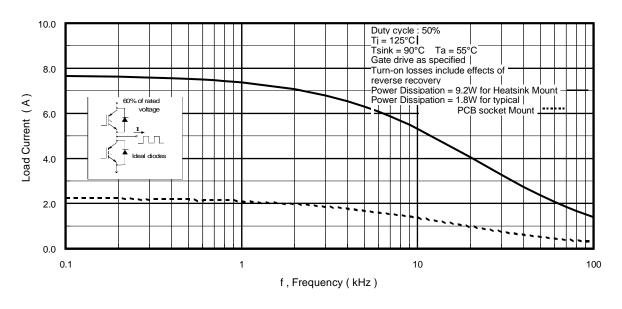
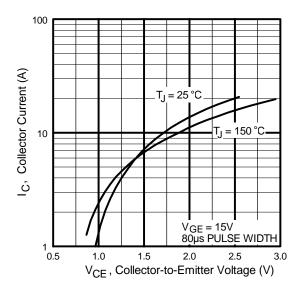


Fig. 1 - Typical Load Current vs. Frequency (Load Current = I_{RMS} of fundamental)



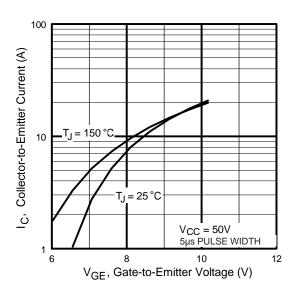
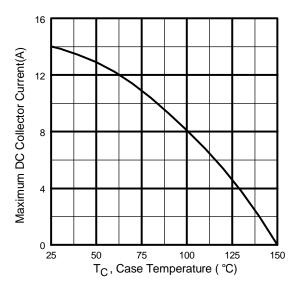


Fig. 2 - Typical Output Characteristics

Fig. 3 - Typical Transfer Characteristics

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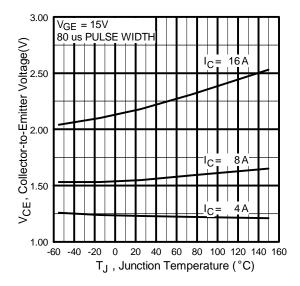


Fig. 4 - Maximum Collector Current vs. Case Temperature

Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

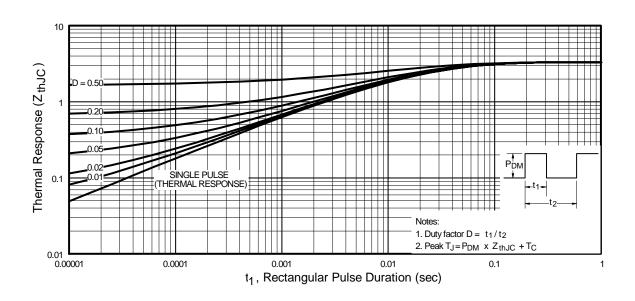
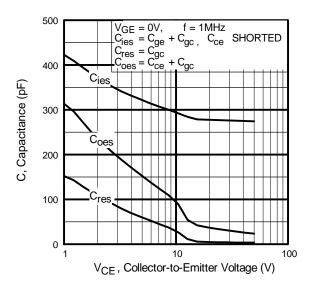


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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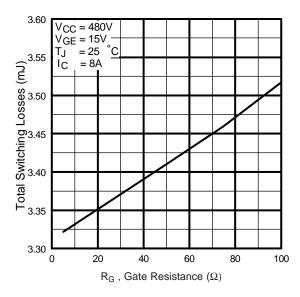
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20 V_{CC} = 400V I_C = 8A 15 10 0 0 5 10 15 20 Q_G, Total Gate Charge (nC)

Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage



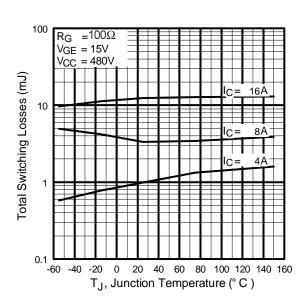


Fig. 9 - Typical Switching Losses vs. Gate Resistance

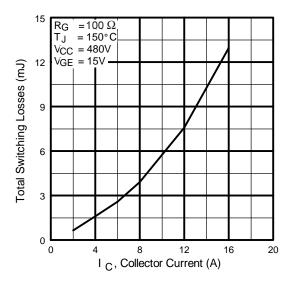
Fig. 10 - Typical Switching Losses vs. Junction Temperature

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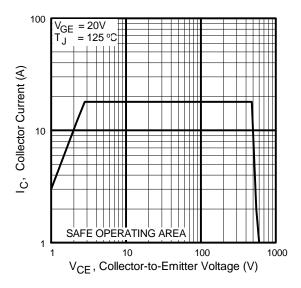


Fig. 11 - Typical Switching Losses vs. Collector Current

Fig. 12 - Turn-Off SOA

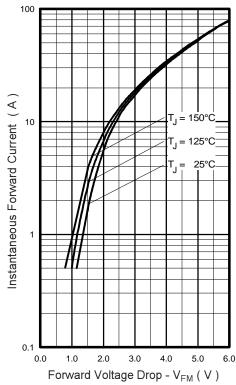


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

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1_F = 8.0A 1_F = 4.0A 1_F = 4.0A 1_F = 4.0A 1_F = 4.0A 1_F = 2.00V 1_J = 125°C 1_J = 25°C 1_J = 25°C 100 di f/dt - (A/μs)

Fig. 14 - Typical Reverse Recovery vs. dif/dt

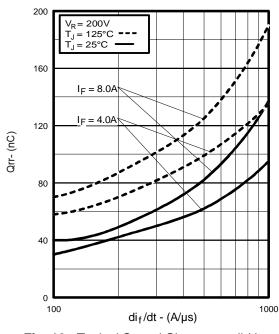


Fig. 16 - Typical Stored Charge vs. dif/dt

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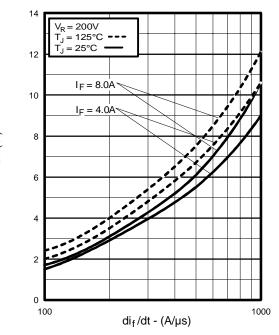


Fig. 15 - Typical Recovery Current vs. dif/dt

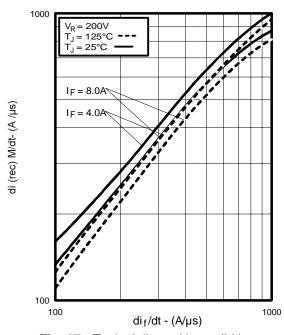
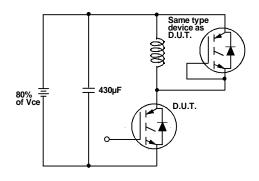


Fig. 17 - Typical $di_{(rec)M}/dt$ vs. di_f/dt ,



 $\label{eq:Fig. 18a} \textbf{Fig. 18a} \textbf{ -} \textbf{ Test Circuit for Measurement of } I_{LM}, E_{on}, E_{off(diode)}, t_{rr}, Q_{rr}, I_{rr}, t_{d(on)}, t_r, t_{d(off)}, t_f$

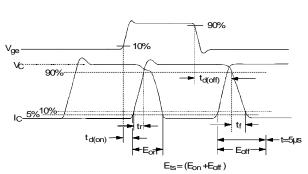
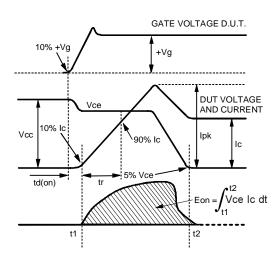
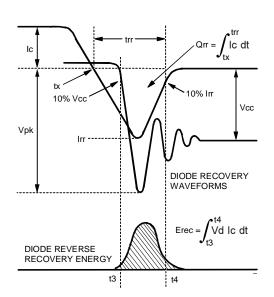


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining $E_{\text{off}},\,t_{\text{d(off)}},\,t_{\text{f}}$





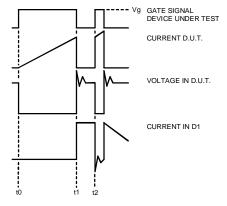


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

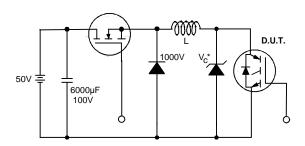


Figure 19. Clamped Inductive Load Test Circuit

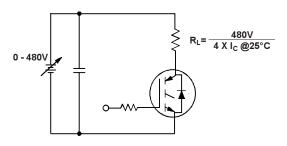


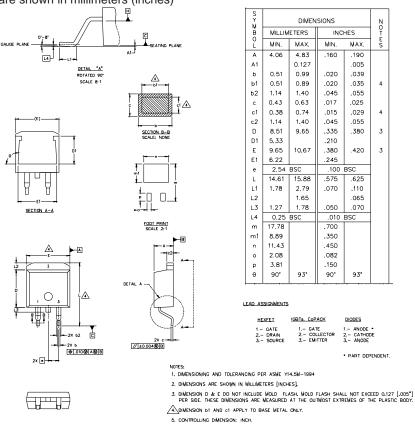
Figure 20. Pulsed Collector Current Test Circuit

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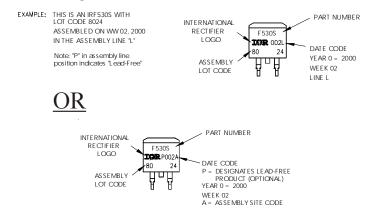
TOR Rectifier

D²Pak Package Outline

Dimensions are shown in millimeters (inches)



D²Pak Part Marking Information

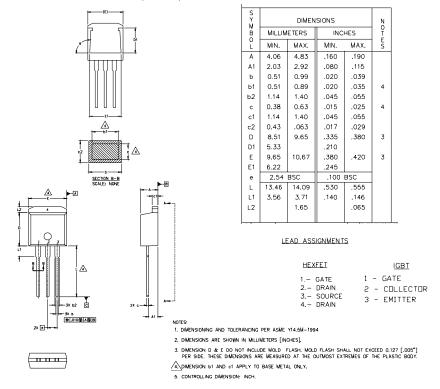


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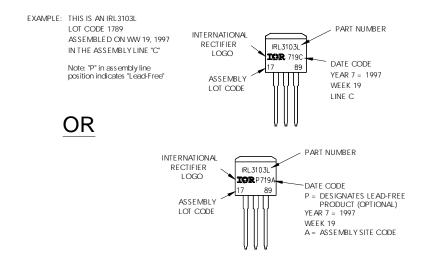
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TO-262 Package Outline

Dimensions are shown in millimeters (inches)



TO-262 Part Marking Information

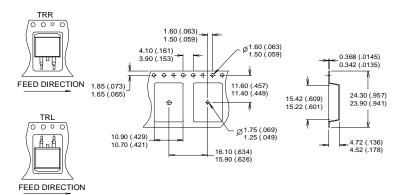


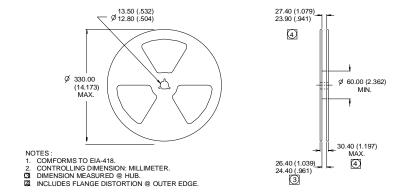
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D²Pak Tape & Reel Information

Dimensions are shown in millimeters (inches)





Notes:

- ① Repetitive rating: V_{GE}=20V; pulse width limited by maximum junction temperature (figure 20)
- $v_{CC} = 80\% (v_{CES}), v_{GE} = 20V, L = 10\mu H, R_G = 100W (figure 19)$
- ③ Pulse width ≤ $80\mu s$; duty factor ≤ 0.1%.
- 4 Pulse width 5.0µs, single shot.
- ⑤ This only applies to TO-262 package.
- ⑥ This applies to D²Pak, when mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.

Data and specifications subject to change without notice. This product has been designed and qualified for the Industrial market.

Qualification Standards can be found on IR's Web site.



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